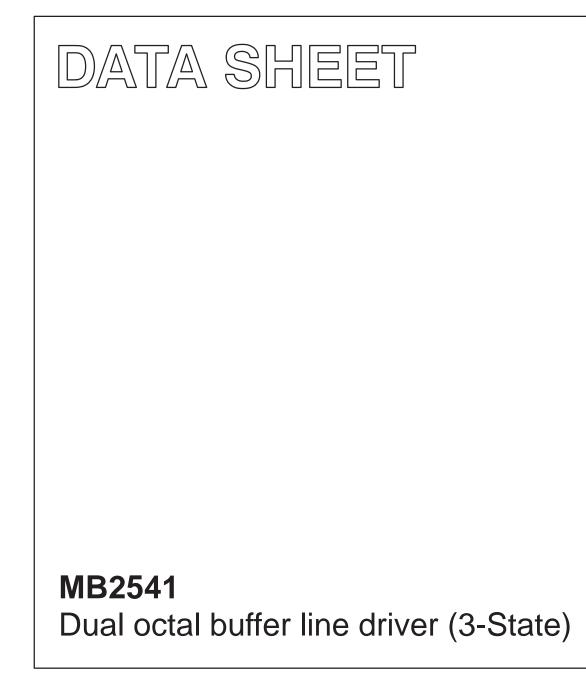
INTEGRATED CIRCUITS



Product specification Supersedes data of 1993 Aug 18 IC23 Data Handbook

1998 Jan 16



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MB2541

FEATURES

- Two 8-bit bus interfaces
- Power-up 3-State
- Multiple V_{CC} and GND pins minimize switching noise
- Provides ideal interface and increases fan-out of MOS Microprocessors
- 3-State buffers sink 64mA and source 32mA
- Latch-up protection exceeds 500mA per Jedec Std 17
- ESD protection exceeds 2000 V per MIL STD 883 Method 3015 and 200 V per Machine Model
- Inputs are disabled during 3-State mode

QUICK REFERENCE DATA

DESCRIPTION

The MB2541 high-performance BiCMOS device combines low static and dynamic power dissipation with high speed and high output drive.

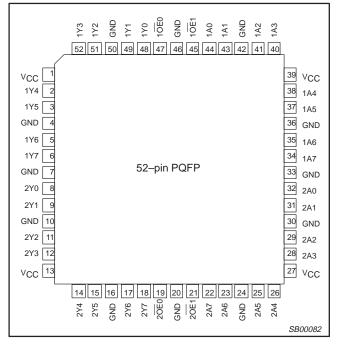
The MB2541 has two 8-bit buffers that are ideal for driving bus lines. The outputs are all capable of sinking 64mA and sourcing 32mA.

SYMBOL	PARAMETER	CONDITIONS T _{amb} = 25°C; GND = 0V	TYPICAL	UNIT
t _{PLH} t _{PHL}	Propagation delay nlx to nYx	C _L = 50pF; V _{CC} = 5V	3.0 3.1	ns
C _{IN}	Input capacitance	$V_I = 0V \text{ or } V_{CC}$	4	pF
C _{OUT}	Output capacitance	$V_{O} = 0V \text{ or } V_{CC}; 3-State$	7	pF
I _{CCZ}	Total supply current	Outputs disabled; V_{CC} =5.5V	65	μΑ

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER
52-pin plastic Quad Flat Pack	-40°C to +85°C	MB2541 BB	MB2541 BB	SOT379-1

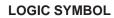
PIN CONFIGURATION

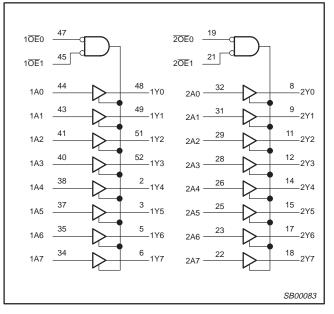


PIN DESCRIPTION

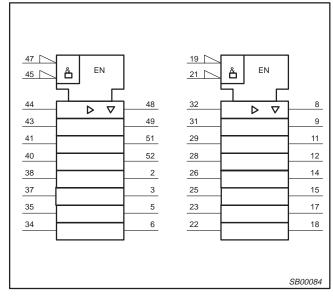
PIN NUMBER	SYMBOL	NAME AND FUNCTION					
44, 43, 41, 40, 38, 37, 35, 34, 32, 31, 29, 28, 26, 25, 23, 22	1A0 – 1A7 2A0 – 2A7	Data inputs					
48, 49, 51, 52, 2, 3, 5, 6, 8, 9, 11, 12, 14, 15, 17, 18	1Y0 – 1Y7, 2Y0 – 2Y7	Data outputs					
47, 45, 19, 21	10E0, 10E1, 20E0, 20E1	Output enables					
4, 7, 10, 16, 20, 24, 30, 33, 36, 42, 46, 50	GND	Ground (0V)					
1, 13, 27, 39	V _{CC}	Positive supply voltage					

MB2541





LOGIC SYMBOL (IEEE/IEC)



FUNCTION TABLE

	INPUTS	OUTPUTS	
n <mark>OE</mark> 0	n <mark>OE</mark> 1	nlx	nYx
L	L	L	L
L	L	н	н
х	н	х	Z
Н	Х	Х	Z

ABSOLUTE MAXIMUM RATINGS^{1, 2}

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +7.0	V
I _{IK}	DC input diode current	V ₁ < 0	-18	mA
VI	DC input voltage ³		-1.2 to +7.0	V
I _{ОК}	DC output diode current	V _O < 0	-50	mA
V _{OUT}	DC output voltage ³	output in Off or High state	-0.5 to +5.5	V
I _{OUT}	DC output current	output in Low state	128	mA
T _{stg}	Storage temperature range		-65 to 150	°C

NOTES:

2. The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability. The maximum junction temperature of this integrated circuit should not exceed 150°C.

The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

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^{1.} Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

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RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	LIM	UNIT	
		Min	Max	
V _{CC}	DC supply voltage	4.5	5.5	V
VI	Input voltage	0	V _{CC}	V
V _{IH}	High-level input voltage	2.0		V
V _{IL}	Low-level Input voltage		0.8	V
I _{ОН}	High-level output current		-32	mA
I _{OL}	Low-level output current		64	mA
$\Delta t/\Delta v$	Input transition rise or fall rate	0	10	ns/V
T _{amb}	Operating free-air temperature range	-40	+85	°C

DC ELECTRICAL CHARACTERISTICS

					LIMITS			
SYMBOL	PARAMETER	TEST CONDITIONS	Ta	_{mb} = +25	°C	T _{amb} = to +	UNIT	
			Min	Тур	Max	Min	Max	
V _{IK}	Input clamp voltage	$V_{CC} = 4.5V; I_{IK} = -18mA$		-0.9	-1.2		-1.2	V
		V_{CC} = 4.5V; I_{OH} = –3mA; V_{I} = V_{IL} or V_{IH}	2.5	2.9		2.5		V
V _{OH}	High-level output voltage	V_{CC} = 5.0V; I_{OH} = –3mA; V_{I} = V_{IL} or V_{IH}	3.0	3.4		3.0		V
		V_{CC} = 4.5V; I_{OH} = -32mA; V_I = V_{IL} or V_{IH}	2.0	2.4		2.0		V
V _{OL}	Low-level output voltage	V_{CC} = 4.5V; I_{OL} = 64mA; V_I = V_{IL} or V_{IH}		0.42	0.55		0.55	V
Ц	Input leakage current	V _{CC} = 5.5V; V _I = GND or 5.5V		±0.01	±1.0		±1.0	μA
I _{OFF}	Power-off leakage current	V_{CC} = 0.0V; V_O or $V_I \le 4.5V$		±5.0	±100		±100	μA
I _{PU} /I _{PD}	Power-up/down 3-State output current	$V_{\underline{CC}} = 2.0V; V_{O} = 0.5V; V_{I} = GND \text{ or } V_{CC};$ $V_{OE} = V_{CC}$		±5.0	±50		±50	μA
I _{OZH}	3-State output High current	V_{CC} = 5.5V; V_{O} = 2.7V; V_{I} = V_{IL} or V_{IH}		5.0	50		50	μA
I _{OZL}	3-State output Low current	V_{CC} = 5.5V; V_{O} = 0.5V; V_{I} = V_{IL} or V_{IH}		-5.0	-50		-50	μA
I _{CEX}	Output high leakage current	V_{CC} = 5.5V; V_{O} = 5.5V; V_{I} = GND or V_{CC}		5.0	50		50	μA
Ι _Ο	Output current ¹	$V_{CC} = 5.5V; V_{O} = 2.5V$	-50	-70	-180	-50	-180	mA
I _{CCH}		V_{CC} = 5.5V; Outputs High, V_I = GND or V_{CC}		65	250		250	μA
I _{CCL}	Quiescent supply current	V_{CC} = 5.5V; Outputs Low, V_{I} = GND or V_{CC}		48	60		60	mA
I _{CCZ}		V_{CC} = 5.5V; Outputs 3-State; V _I = GND or V _{CC}		65	250		250	μA
ΔI _{CC}	Additional supply current per input pin ²	Outputs enabled, one input at 3.4V, other inputs at V _{CC} or GND; V _{CC} = 5.5V		0.5	1.5		1.5	mA

NOTES:

Not more than one output should be tested at a time, and the duration of the test should not exceed one second.
This is the increase in supply current for each input at 3.4V.

MB2541

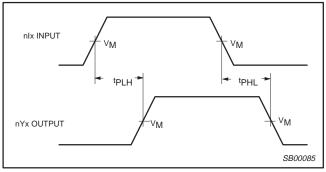
AC CHARACTERISTICS

GND = 0V; $t_R = t_F = 2.5 \text{ns}$; $C_L = 50 \text{pF}$, $R_L = 500 \Omega$

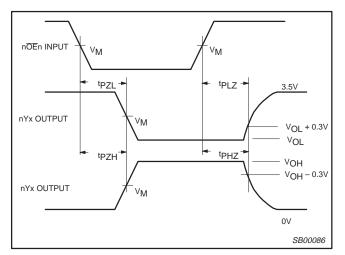
					LIMI	ſS		
SYMBOL	PARAMETER	WAVEFORM	T ₂ ۷	amb = +25° ′ _{CC} = +5.0′	C V	$T_{amb} = -40^{\circ}$ $V_{CC} = +5.$	°C to +85°C .0V ±0.5V	UNIT
			Min	Тур	Мах	Min	Max	
t _{PLH} t _{PHL}	Propagation delay nlx to nYx	1	1.2 1.2	3.0 3.1	4.5 4.5	1.2 1.2	5.1 5.1	ns
t _{PZH} t _{PZL}	Output enable time to High and Low level	2	1.3 2.1	3.6 4.7	5.2 6.1	1.3 2.1	5.8 7.1	ns
t _{PHZ} t _{PLZ}	Output disable time from High and Low level	2	1.8 1.7	4.3 4.0	6.2 5.4	1.8 1.7	6.8 5.9	ns

AC WAVEFORMS

 V_{M} = 1.5V, V_{IN} = GND to 3.0V



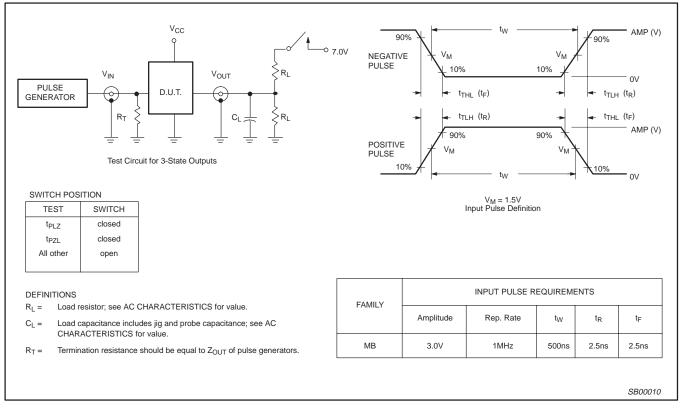
Waveform 1. Waveforms Showing the Input (An) to Output (Yn) Propagation Delays



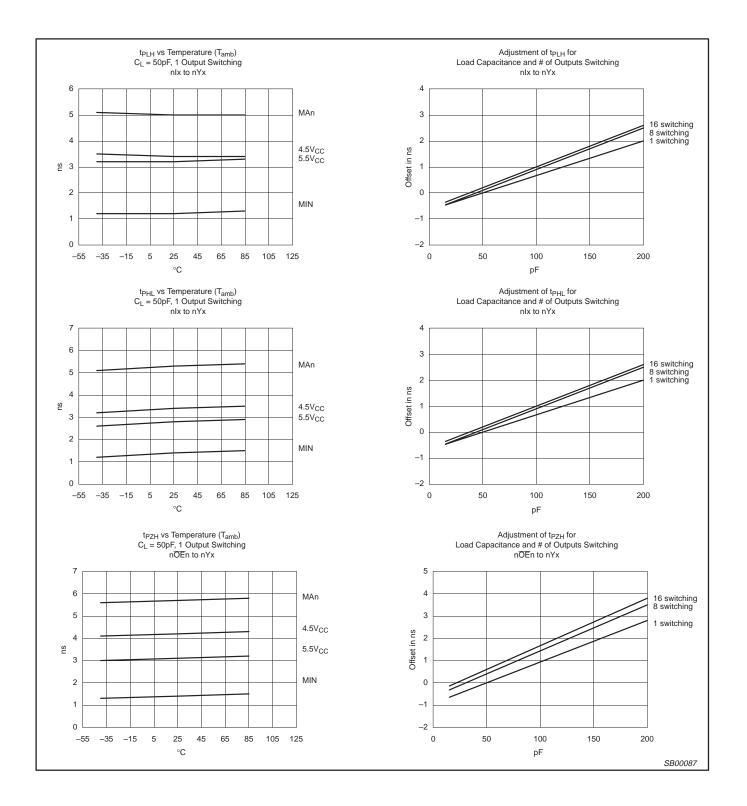
Waveform 2. Waveforms Showing the 3-State Output Enable and Disable Times

MB2541

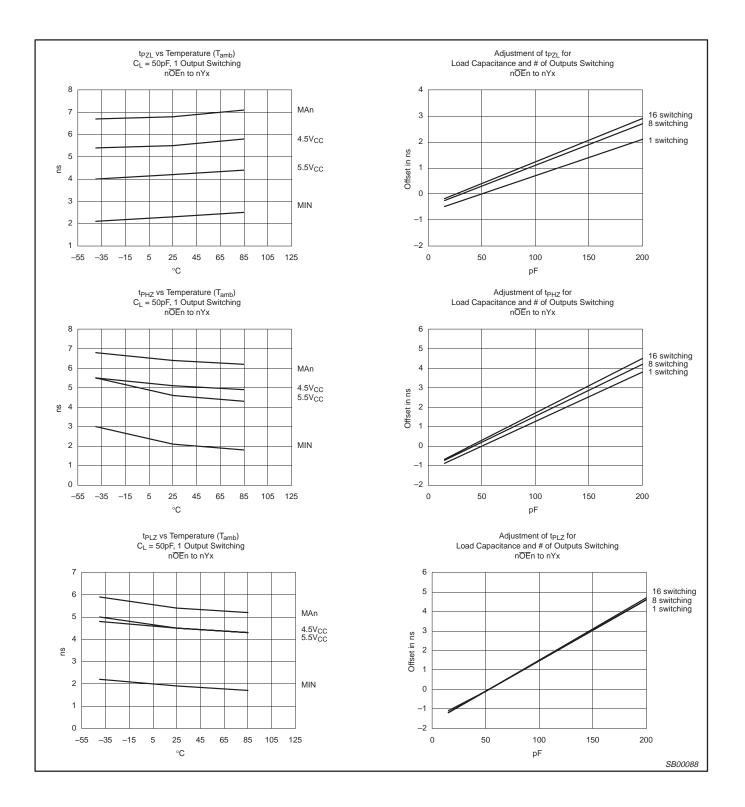
TEST CIRCUIT AND WAVEFORMS



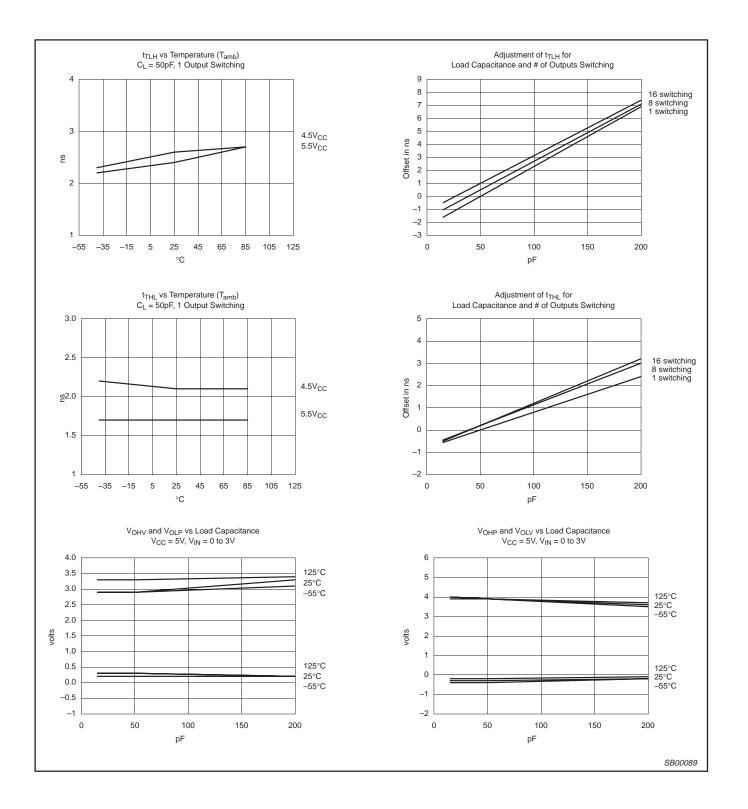
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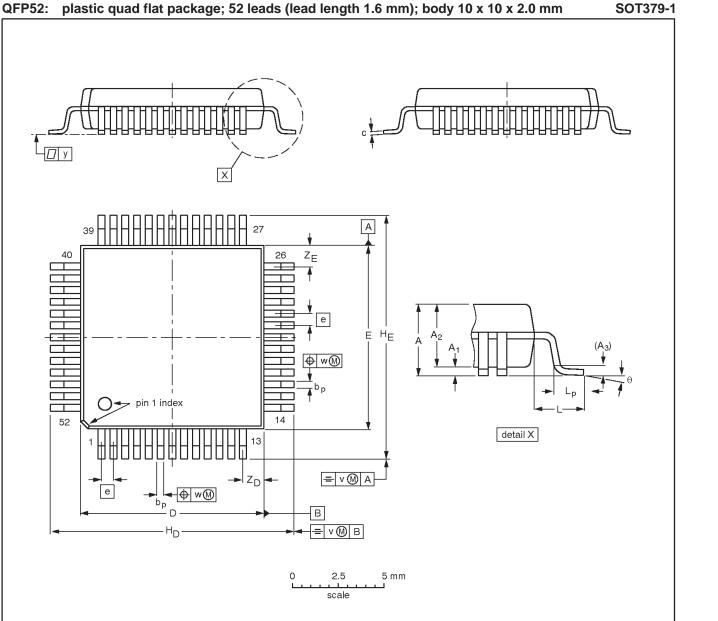
C

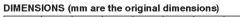
е

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Dual octal buffer line driver (3-State)





UNIT	A max.	A ₁	A ₂	Α3	b _р	с	D ⁽¹⁾	E ⁽¹⁾	е	HD	Η _E	L	Lp	v	w	У	Z _D ⁽¹⁾	Z _E ⁽¹⁾	θ
mm	2.45	0.45 0.25	2.10 1.95	0.25	0.38 0.22	0.23 0.13	10.1 9.9	10.1 9.9	0.65	13.45 12.95	13.45 12.95	1.60	0.95 0.65	0.20	0.12	0.10	1.24 0.95	1.24 0.95	7° 0°

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	RENCES	EUROPEAN	ISSUE DATE	
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT379-1		MO-108				-95-02-04 97-08-04

Product specification

Dual octal buffer line driver (3-State)

MB2541

NOTES

Dual octal buffer line driver (3-State)

MB2541

Data sheet status

Data sheet status	Product status	Definition ^[1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
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Document order number:

9397-750-03512

Date of release: 05-96

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